

PRELIMINARY

# 1214GN-180LV

180 Watts - 50 Volts, 3ms, 30% Broad Band 1200 - 1400 MHz

#### **GENERAL DESCRIPTION** CASE OUTLINE 55-KR The 1214GN-180LV is an internally matched, COMMON SOURCE, **Common Source** class AB GaN on SiC HEMT transistor capable of providing over 16.6dB gain, 180 Watts of pulsed RF output power at 3ms pulse width, 30% duty factor across the 1200 to 1400 MHz band. The transistor has internal pre-match for optimal performance. This hermetically sealed transistor is designed for L-Band Radar applications. It utilizes gold metallization and eutectic attach to provide highest reliability and superior ruggedness. **ABSOLUTE MAXIMUM RATINGS** Maximum Power Dissipation Device Dissipation @ 25°C 300 W **Maximum Voltage and Current** Drain-Source Voltage (V<sub>DSS</sub>) 150 V Gate-Source Voltage (V<sub>GS</sub>) -8 to +0 V **Maximum Temperatures** Storage Temperature (T<sub>STG</sub>)-55 to +125 °C Operating Junction Temperature +250 °C

### **ELECTRICAL CHARACTERISTICS @ 25°C**

Symbol	Characteristics	Test Conditions	Min	Тур	Мах	Units
Pout	Output Power	Pout=180W, Freq=1200, 1300, 1400 MHz	180			W
Gp	Power Gain	Pout=180W, Freq=1200, 1300, 1400 MHz	16.6	17		dB
ηd	Drain Efficiency	Pout=180W, Freq=1200, 1300, 1400 MHz	54	60		%
Dr	Droop	Pout=180W, Freq=1200, 1300, 1400 MHz			1.0	dB
VSWR-T	Load Mismatch Tolerance	Pout=180W, Freq=1400 MHz			3:1	
Өјс	Thermal Resistance	Pulse Width=3mS, Duty=30%			0.73	°C/W

 Bias Condition: Vdd=+50V, Idq=60mA average current (Vgs= -2.0 ~ -4.5V) with constant gate Bias

### FUNCTIONAL CHARACTERISTICS @ 25°C

I <sub>D(Off)</sub>	Drain leakage current	$V_{gS} = -8V, V_D = 50V$		12	mA
I <sub>G(Off)</sub>	Gate leakage current	$V_{gS} = -8V, V_D = 0V$		8	mA
BV <sub>DSS</sub>	Drain-source breakdown voltage	$V_{gs} = -8V, I_D = 28mA$	150		V

• DC parameters pass/failure criteria will be revised after mass production DC parameters distributions have been determined.

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#### **Export Classification: EAR 99**

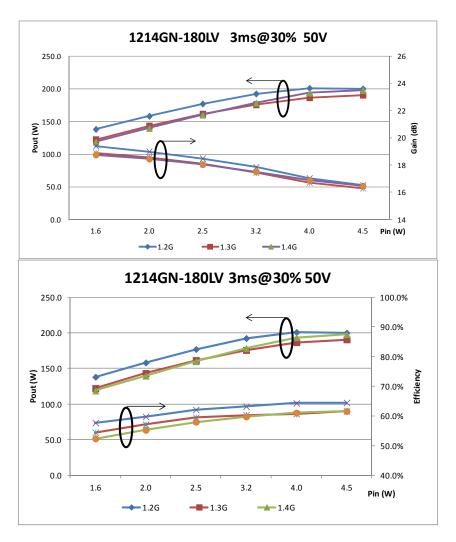
For the most current data, consult MICROSEMI's website: <u>www.MICROSEMI.com</u> Specifications are subject to change, consult the RFIS factory at (408) <u>986-8031</u> for the latest information



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Freq(GH)	Pin (W)	Pout (W)	ld (A)	RL (dB)	Eff(%)	G (dB)	Droop (dB)
1.2	4	204	2.03	-13.8	61%	17.1	0.5
1.3	4	202	2.07	-11.4	60%	17.06	0.45
1.4	4	203	2.03	-13.6	61%	17.09	0.45

### **Typical Performance Data**

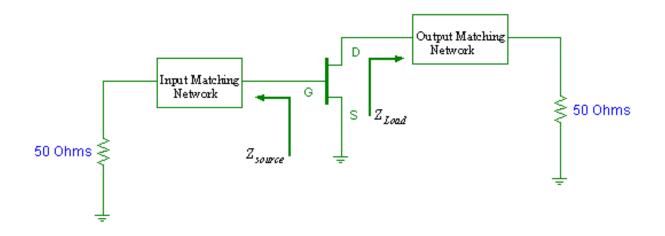


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### **Transistor Impedance Information**



Note:  $Z_{in}$  is looking into the input circuit;  $Z_{Load}$  is looking into the output circuit.

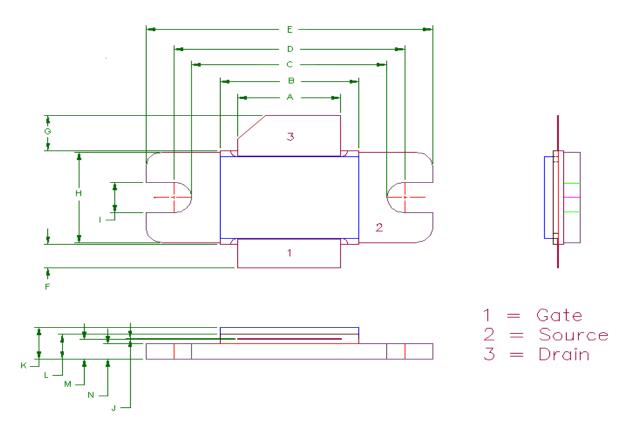
Impedance Data				
Freq (GHz)	Zs	ZI		
1.2	2.615 – j2.33	2.904 + j1.436		
1.3	2.642 - j1.173	3.36 + j1.22		
1.4	2.8 + j0.025	3.09 + j0.781		

### Please call the representative for detailed circuit configuration.



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#### **55-KR PACKAGE DIMENSION**



Dimension	Min (mil)	Min (mm)	Max (mil)	Max (mm)
Α	370	9.40	372	9.44
В	498	12.65	500	12.7
С	700	17.78	702	17.83
D	830	21.08	832	21.13
E	1030	26.16	1032	26.21
F	101	2.56	102	2.59
G	151	3.84	152	3.86
Н	385	9.78	387	9.83
I	130	3.30	132	3.35
J	003	.076	004	0.10
K	135	3.43	137	3.48
L	105	2.67	107	2.72
М	085	2.16	86	2.18
N	065	1.65	66	1.68

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#### **Revision History**

Revision Level / Date	Para. Affected	Description
0.1 / 12 June 2013	-	Initial Preliminary Release

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